

HAT3018R, HAT3018RJ

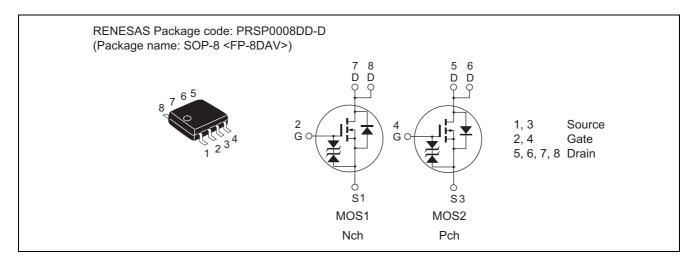
Silicon N/P Channel Power MOS FET High Speed Power Switching

REJ03G0127-0200 Rev.2.00 Nov 04, 2008

Features

- Low on-resistance
- Capable of 4.5 V gate drive
- High density mounting
- "J" is for Automotive application High temperature D-S leakage guarantee Avalanche rating

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	HAT3	3018R	HAT3018RJ		Unit
		Nch	Pch	Nch	Pch	
Drain to source voltage	V _{DSS}	60	-60	60	-60	V
Gate to source voltage	V _{GSS}	±20	±20	±20	±20	V
Drain current	I _D	6	- 5	6	- 5	Α
Drain peak current	I _D (pulse) ^{Note1}	48	-40	48	-40	Α
Avalanche current	I _{AP} Note4	_	_	6	-5	Α
Avalanche energy	E _{AR} Note4	_	_	3.08	2.14	mJ
Channel dissipation	Pch ^{Note2}	2	2	2	2	W
Channel dissipation	Pch ^{Note3}	3	3	3	3	W
Channel temperature	Tch	150	150	150	150	°C
Storage temperature	Tstg	-55 to +150	-55 to +150	-55 to +150	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

- 2. 1 Drive operation: When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW \leq 10 s
- 3. 2 Drive operation: When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW \leq 10 s
- 4. Value at Tch = 25°C, Rg \geq 50 Ω

Electrical Characteristics

• N Channel

 $(Ta = 25^{\circ}C)$

Item		Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage		$V_{(BR)DSS}$	60	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to Source breakdown voltage		$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \mu A, V_{DS} = 0$
Zero gate voltage dra	ain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 60 \text{ V}, V_{GS} = 0$
Zero gate voltage	HAT3018R	I _{DSS}	_	_	_	μΑ	V _{DS} = 48 V, V _{GS} = 0
drain current	HAT3018RJ	I _{DSS}	_	_	10	μΑ	Ta = 125°C
Gate to source leak of	current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Gate to source cutoff	voltage	$V_{GS(off)}$	1.5	_	2.5	V	V _{DS} = 10 V, I _D = 1 mA
Forward transfer adn	nittance	y _{fs}	6	9.5	_	S	$I_D = 3 A^{\text{Note 5}}, V_{DS} = 10 V$
Static drain to source	on state	R _{DS(on)}	_	28	35	mΩ	$I_D = 3 A^{\text{Note 5}}, V_{GS} = 10 V$
resistance		R _{DS(on)}	_	40	50	mΩ	$I_D = 3 A^{\text{Note 5}}, V_{GS} = 4.5 V$
Input capacitance		Ciss	_	1000	_	pF	V _{DS} = 10 V, V _{GS} = 0
Output capacitance		Coss	_	145	_	pF	f = 1 MHz
Reverse transfer capacitance		Crss	_	85	_	pF	
Total gate charge		Qg	_	15	_	nC	V _{DD} = 25 V
Gate to source charge		Qgs	_	2	_	nC	V _{GS} = 10 V
Gate to drain charge		Qgd	_	3	_	nC	I _D = 6 A
Turn-on delay time		t _{d(on)}	_	12	_	ns	$V_{GS} = 10 \text{ V}, I_{D} = 3 \text{ A}$
Rise time		t _r	_	10	_	ns	$V_{DD} \cong 30 \text{ V}$
Turn-off delay time		t _{d(off)}	_	60	_	ns	$R_L = 10 \Omega$
Fall time		t _f	_	11	_	ns	$R_G = 4.7 \Omega$
Body-drain diode forward voltage		V_{DF}	_	0.82	1.07	V	$I_F = 6 \text{ A}, V_{GS} = 0^{\text{Note 5}}$
Body-drain diode rev	erse recovery	t _{rr}	_	40	_	ns	$I_F = 6 \text{ A}, V_{GS} = 0$
time							$di_F/dt = 100 \text{ A/ } \mu\text{s}$

Notes: 5. Pulse test

• P Channel

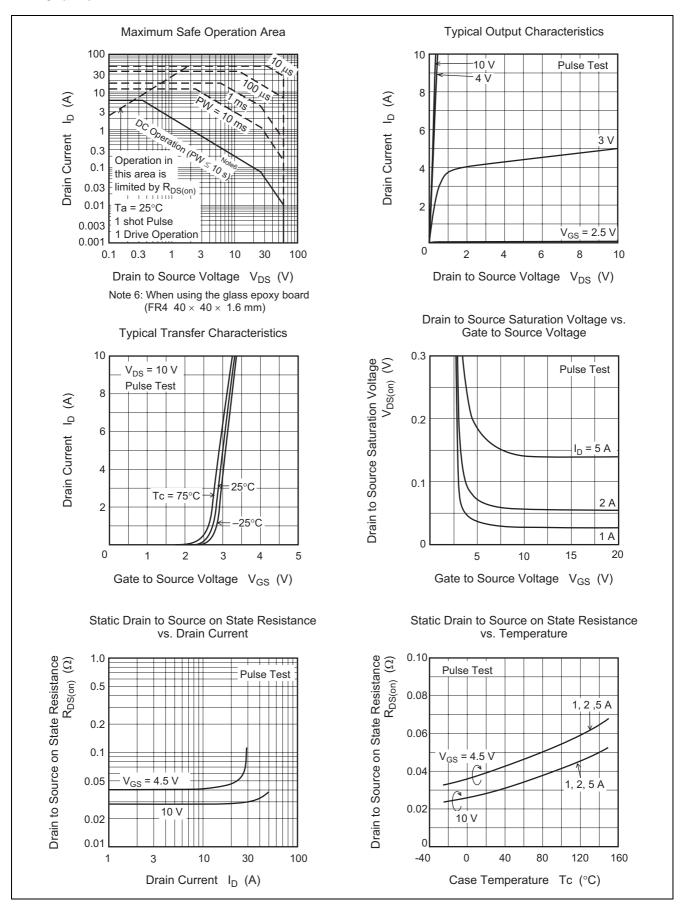
 $(Ta = 25^{\circ}C)$

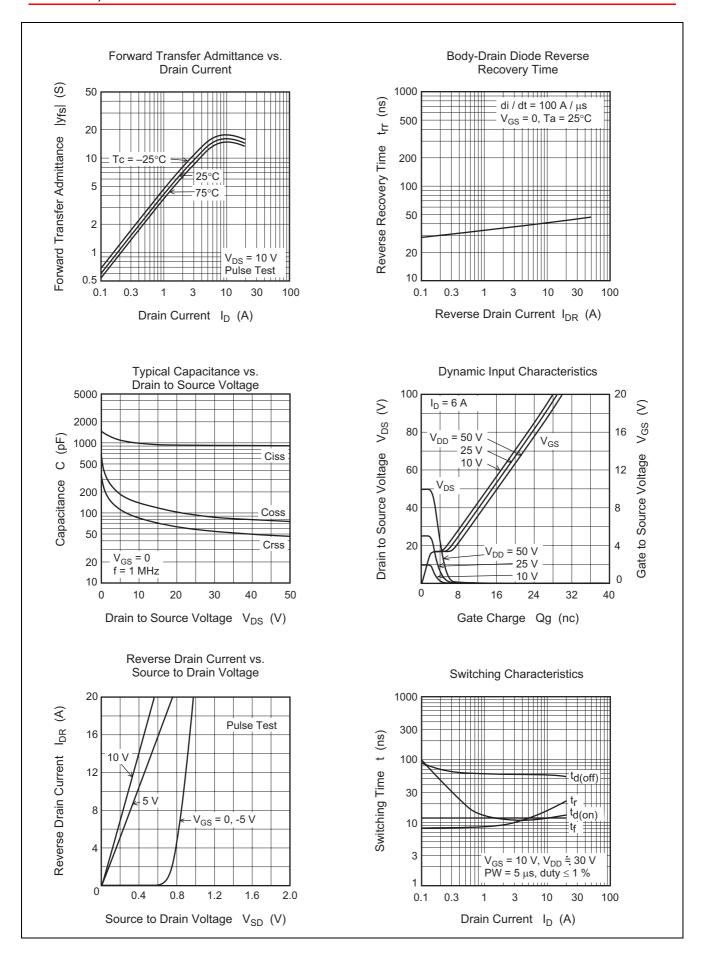
Item		Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage		V _{(BR)DSS}	-60	_	_	V	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to Source breakdown voltage		$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \mu A, V_{DS} = 0$
Zero gate voltage drain current		I _{DSS}	_	_	-1	μΑ	$V_{DS} = -60 \text{ V}, V_{GS} = 0$
Zero gate voltage	HAT3018R	I _{DSS}	_	_	_	μΑ	$V_{DS} = -48 \text{ V}, V_{GS} = 0$
drain current	HAT3018RJ	I _{DSS}	_	_	-10	μΑ	Ta = 125°C
Gate to source leak	current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Gate to source cuto	off voltage	$V_{GS(off)}$	-1.0	_	-2.5	V	$V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$
Forward transfer ad	Imittance	y _{fs}	3	5	_	S	$I_D = -2.5 \text{ A}^{\text{Note 5}}, V_{DS} = -10 \text{ V}$
Static drain to source	ce on state	R _{DS(on)}	_	60	76	mΩ	$I_D = -2.5 \text{ A}^{\text{Note 5}}, V_{GS} = -10 \text{ V}$
resistance		R _{DS(on)}	_	90	130	mΩ	$I_D = -2.5 \text{ A}^{\text{Note 5}}, V_{GS} = -4.5V$
Input capacitance		Ciss	_	1350	_	pF	$V_{DS} = -10 \text{ V}, V_{GS} = 0$
Output capacitance		Coss	_	135	_	pF	f = 1 MHz
Reverse transfer capacitance		Crss	_	85	_	pF	
Total gate charge		Qg	_	21	_	nC	V _{DD} = -25 V
Gate to source charge		Qgs	_	3	_	nC	V _{GS} = −10 V
Gate to drain charge		Qgd	_	4	_	nC	$I_D = -5 A$
Turn-on delay time		t _{d(on)}	_	20	_	ns	$V_{GS} = -10 \text{ V}, I_{D} = -2.5 \text{ A}$
Rise time		t _r	_	15	_	ns	V _{DD} ≅ -30 V
Turn-off delay time		t _{d(off)}	_	55	_	ns	$R_L = 12 \Omega$
Fall time		t _f	_	10	_	ns	$R_G = 4.7 \Omega$
Body-drain diode forward voltage		V_{DF}	_	-0.85	-1.10	V	$I_F = -5 \text{ A}, V_{GS} = 0^{\text{Note } 5}$
Body-drain diode reverse recovery		t _{rr}	_	25	_	ns	$I_F = -5 \text{ A}, V_{GS} = 0$
time							di _F /dt = 100A/ μs

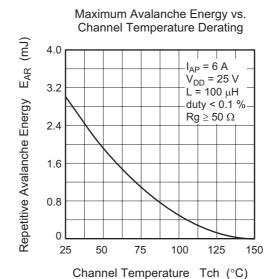
Notes: 5. Pulse test

Main Characteristics

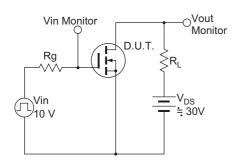
• N Channel



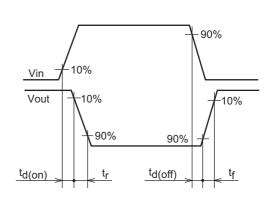




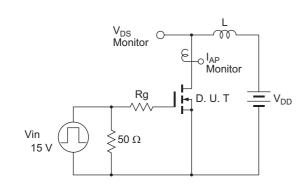
Switching Time Test Circuit



Switching Time Waveform



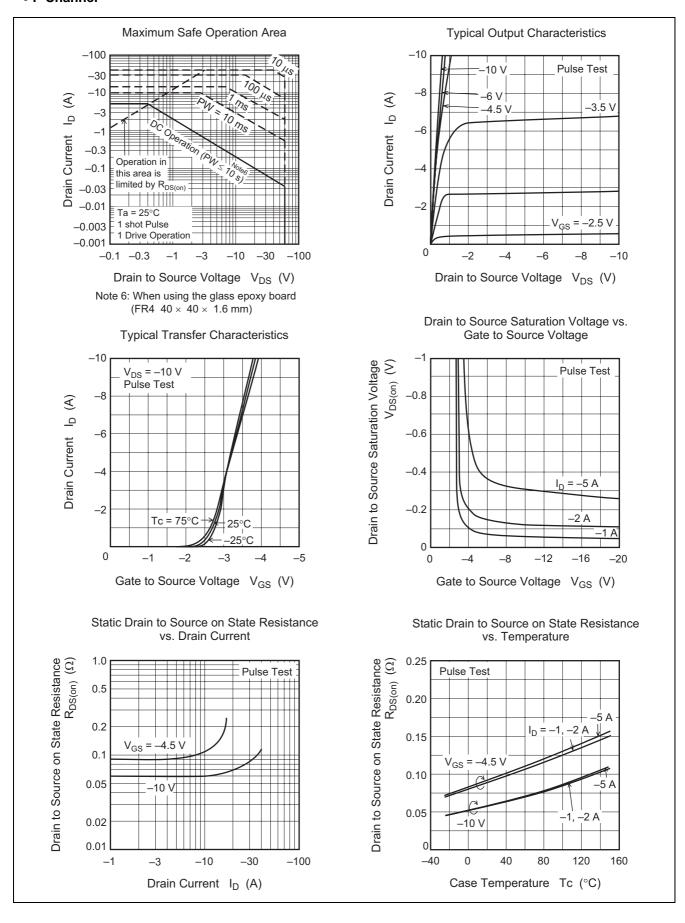
Avalanche Test Circuit

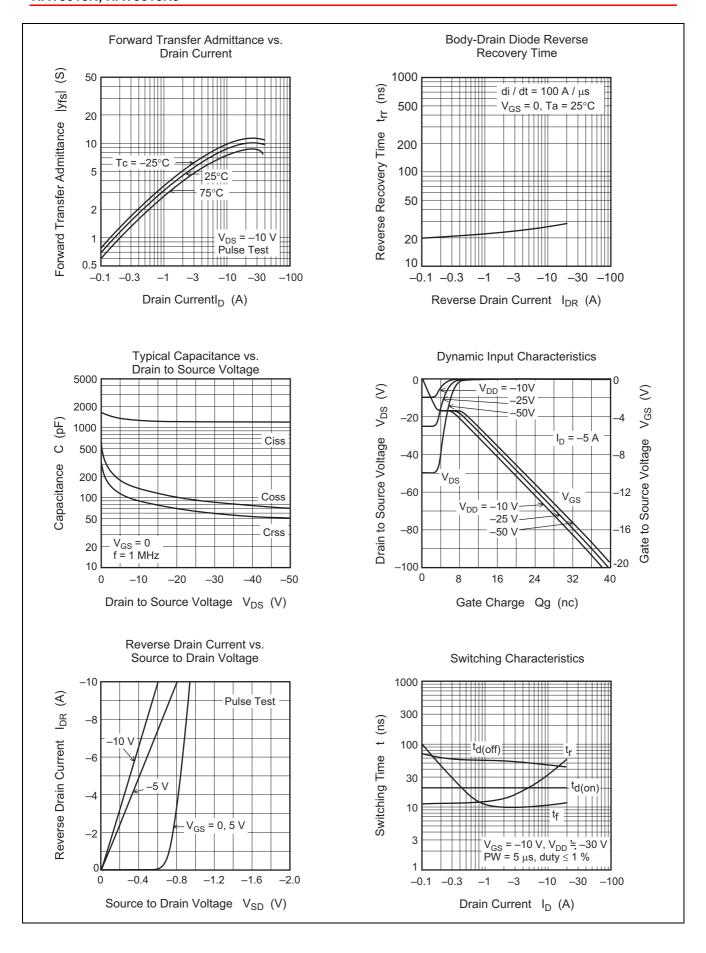


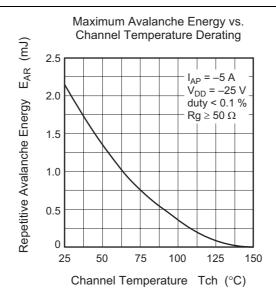
Avalanche Waveform

$$I_{AP}$$
 I_{D}
 V_{DS}

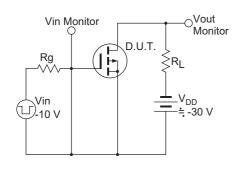
• P Channel



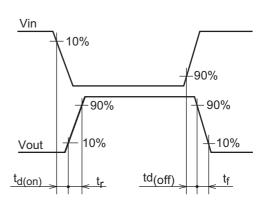




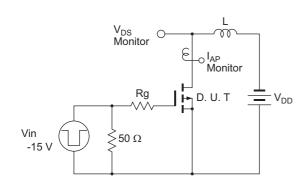
Switching Time Test Circuit



Switching Time Waveform

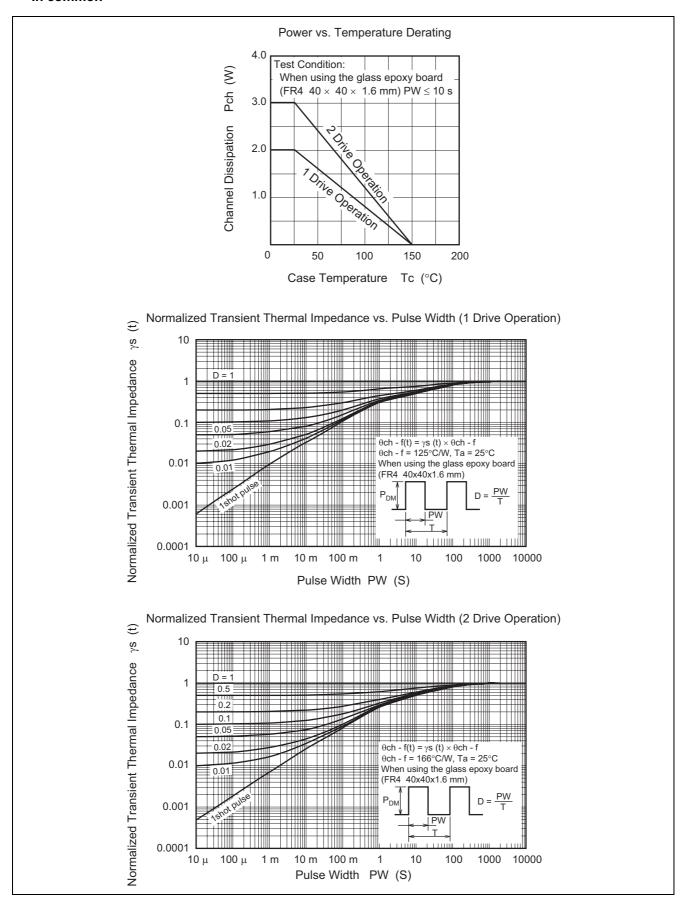


Avalanche Test Circuit

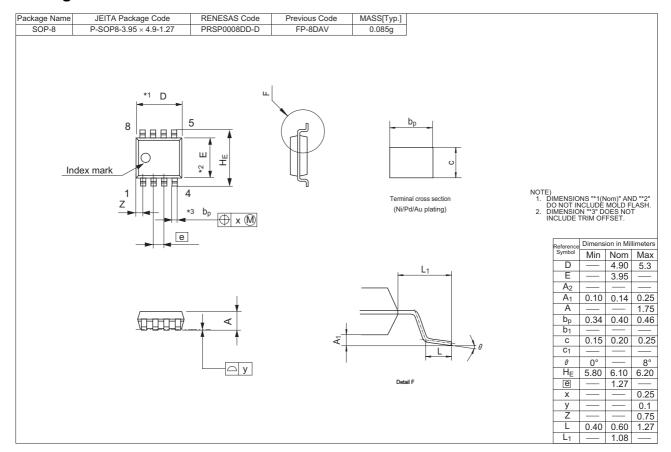


Avalanche Waveform

• In common



Package Dimensions



Ordering Information

Part No.	Quantity	Shipping Container		
HAT3018R-EL-E	2500 pcs.	Taping		
HAT3018RJ-EL-E	2500 pcs.	Taping		

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